

# MC68HC705C8CFU Information

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## General Information

| Parameter                                     | Value                            |
|---|----------------------------------|
| Part Number                                   | MC68HC705C8CFU                   |
| Description                                   | 8BIT MCU W/ BLANK EPROM          |
| PTI   | JDAC                             |
| Material Type                                 | Tested Packaged Device           |
| <a href="#">Life Cycle Description (code)</a> | REMOVED FROM ACTIVE PORTFOLIO(8) |
| Status  | No Longer Manufactured           |

## Package Information

| Parameter             | Value                                |
|-----------------------|--------------------------------------|
| Package Description   | <a href="#">QFP 64 14*14*2.1P0.8</a> |
| JEDEC Pkg Description | PQFP-G64                             |
| Pin/Lead/Ball Count   | 64                                   |
| Package Material      | Plastic                              |
| Mounting Style        | Surface Mount                        |
| Tape & Reel           | No                                   |

## Environmental and Compliance Information

| Parameter  | Value                      |
|--|----------------------------|
| <a href="#">Pb-Free</a>                            | Not Available              |
| <a href="#">RoHS Compliant</a>                     | Not Available              |
| <a href="#">RoHS Certificate of Analysis (CoA)</a> | <a href="#">Contact Us</a> |
| Moisture Sensitivity Level (MSL)                   | 5A                         |
| Floor Life   | 24 HOURS                   |
| Package Peak Temperature (°C)                      | Not Available              |

## Ordering Information

| Parameter   | Value        |
|---|--------------|
| Last Order Date                                     | 30 Aug 2000  |
| Last Ship Date                                      | 31 Aug 2001  |
| Export Control Classification Number (US)           | EAR99        |
| Harmonized Tariff ( <a href="#">US Disclaimer</a> ) | 8542.31.0000 |
| <a href="#">Budgetary Price QTY 1000+ (\$US)</a>    | -            |

## Product/Process Change Notice (PCN)

| Number | Type                  | Title   | Issue Date  | Effectivity Date |
|--------|-----------------------|---|-------------|------------------|
| 6389   | Product Bulletin      | TRAY CHANGE QFP64 14X14   | 01 May 2001 | 02 May 2001      |
| 4969   | Update Notification   | UPDATE NOTICE TO PB4661: XQFP SHIPPING TRAY STANDARDIZATION (4 OF 4)                            | 18 Aug 1999 | 18 Aug 1999      |
| 4661   | Product Bulletin      | XQFP SHIPPING TRAY STANDARDIZATION (4 OF 4)   | 15 Jun 1999 | 16 Jun 1999      |
| 4605   | Product Change Notice | MOS3 CONVERSION TO PEO/BPSG ILD   | 20 Apr 1999 | 29 Jul 1999      |
| 4208   | Product Bulletin      | PACKING MATERIAL/METHOD CHANGE  | 29 Oct 1998 | 30 Oct 1998      |
| 3179   | Product Bulletin      | LABEL CHANGE FOR SQUARE QFP PACKAGE IN TAPE & REEL  | 08 Jan 1998 | 10 Mar 1998      |
| 2907   | Product Change Notice | ADDITION 14X14X2.0MM 64 & 80 LEADS QFP ASSEMBLY IN MCEL   | 16 Jul 1997 | 24 Oct 1997      |
| 2674   | Product Change Notice | CONVERSION TO 6" WAFERS IN MOS 3  | 29 May 1997 | 15 Sep 1997      |
| 2722   | Product Bulletin      | INTRODUCTION OF PINK POLYFORM ENDCAP PACKAGING MATERIAL IN JEDEC TRAY OF ALL QFP/TQFP PACKAGES. | 29 Apr 1997 | 30 Apr 1997      |